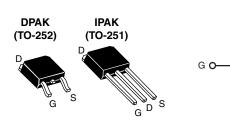


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	100					
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.27				
Q _g (Max.) (nC)	16					
Q _{gs} (nC)	4.4					
Q _{gd} (nC)	7.7					
Configuration	Single					



S N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Surface Mount (IRFR120, SiHFR120)
- Straight Lead (IRFU120, SiHFU120)
- Available in Tape and Reel
- Fast Switching
- Ease of Paralleling
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION								
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)			
Lead (Pb)-free and Halogen-free	SiHFR120-GE3	SiHFR120TR-GE3 ^a	SiHFR120TRR-GE3 ^a	SiHFR120TRL-GE3a	SiHFU120-GE3			
Lead (Pb)-free	IRFR120PbF	IRFR120TRPbF ^a	IRFR120TRRPbF ^a	IRFR120TRLPbF ^a	IRFU120PbF			
	SiHFR120-E3	SiHFR120T-E3 ^a	SiHFR120TR-E3 ^a	SiHFR120TL-E3 ^a	SiHFU120-E3			

Note

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	100	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current	1	7.7			
Continuous Drain Current	ID	4.9	A		
Pulsed Drain Current ^a			I _{DM}	31	
Linear Derating Factor		0.33	0.33	— W/°C	
Linear Derating Factor (PCB Mount) ^e			0.020		
Single Pulse Avalanche Energy ^b		E _{AS}	210	mJ	
Repetitive Avalanche Current ^a			I _{AR}	7.7	А
Repetitive Avalanche Energy ^a			E _{AR}	4.2	mJ
Maximum Power Dissipation	25 °C	D	42	14/	
Maximum Power Dissipation (PCB Mount) ^e	P _D	2.5	- W		
Peak Diode Recovery dV/dtc	dV/dt	5.5	V/ns		
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	- 55 to + 150	°C
Soldering Recommendations (Peak Temperature) ^d	-	260	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 5.3 mH, R_g = 25 Ω , I_{AS} = 7.7 A (see fig. 12).

c. $I_{SD} \le 9.2$ A, dI/dt ≤ 110 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

S13-0171-Rev. C, 04-Feb-13

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COMPLIANT

HALOGEN

FREE

Availab



Vishay Siliconix

THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	-	110				
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	3.0				

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.13	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zaus Osta Valta es Dusis Ouwest		V _{DS} =	= 100 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 4.6 A ^b	-	-	0.27	Ω
Forward Transconductance	g _{fs}	V _{DS} :	= 50 V, I _D = 4.6 A	1.6	-	-	S
Dynamic							•
Input Capacitance	Ciss		$V_{GS} = 0 V$,	-	360	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$	-	150	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	34	-	
Total Gate Charge	Qg			-	-	16	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 V$ $I_D = 9.2 A, V_{DS} = 80 V,$ see fig. 6 and 13 ^b		-	4.4	nC
Gate-Drain Charge	Q _{gd}			-	-	7.7	
Turn-On Delay Time	t _{d(on)}			-	6.8	-	
Rise Time	t _r	- V _{DD} =	= 50 V, I _D = 9.2 A,	-	27	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 18 \Omega$, $R_D = 5.2 \Omega$, see fig. 10 ^b		-	18	-	ns
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25")	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	-	4.5	-	nH
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the		-	-	7.7	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	31	
Body Diode Voltage	V_{SD}	T _J = 25 °C	, $I_{\rm S}$ = 7.7 A, $V_{\rm GS}$ = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T = 25 °C 1	- 0.0 A dl/dt - 100 A/	-	130	260	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 \rm C, I_{\rm F}$	= 9.2 A, dl/dt = 100 A/µs ^b	-	0.65	1.3	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

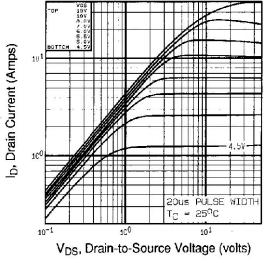


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

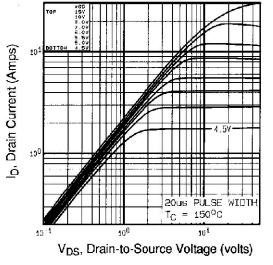


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

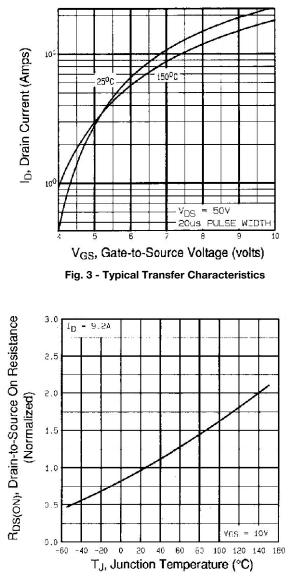


Fig. 4 - Normalized On-Resistance vs. Temperature



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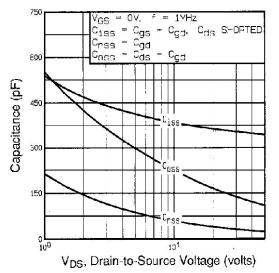


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

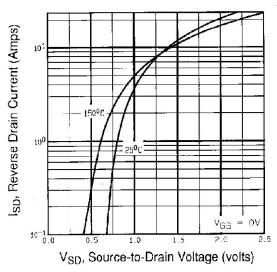


Fig. 7 - Typical Source-Drain Diode Forward Voltage

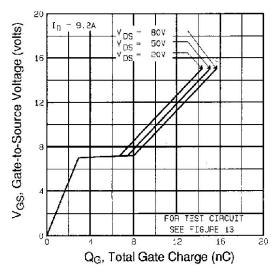


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

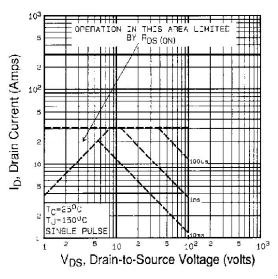


Fig. 8 - Maximum Safe Operating Area



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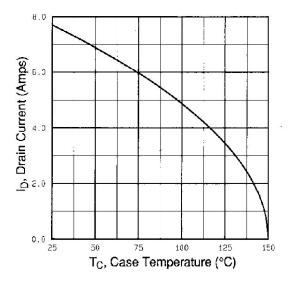


Fig. 9 - Maximum Drain Current vs. Case Temperature

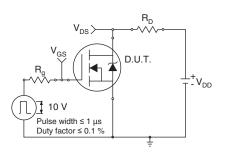


Fig. 10a - Switching Time Test Circuit

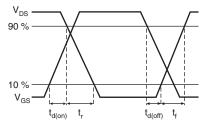


Fig. 10b - Switching Time Waveforms

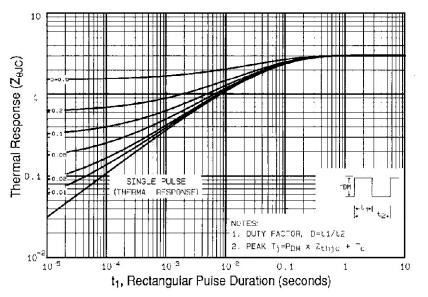


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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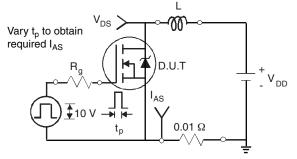


Fig. 12a - Unclamped Inductive Test Circuit

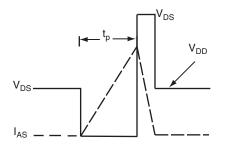


Fig. 12b - Unclamped Inductive Waveforms

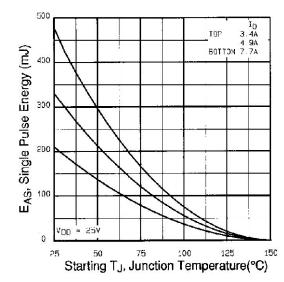


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

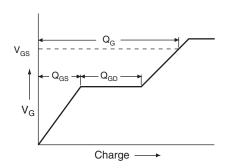


Fig. 13a - Basic Gate Charge Waveform

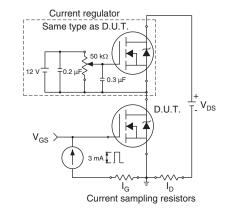


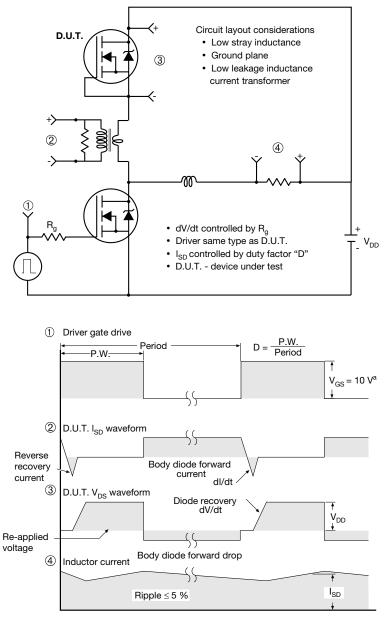
Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



Note

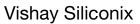
a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

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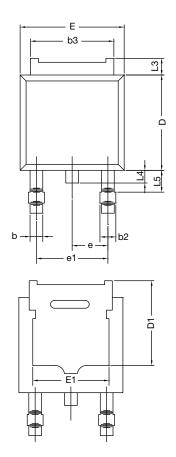
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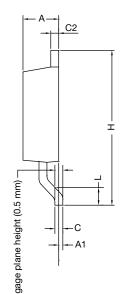
7





TO-252AA Case Outline





	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090	BSC	
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16- DWG: 534	0236-Rev. P, [•] 7	16-May-16			

Notes

• Dimension L3 is for reference only.



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TO-251AA (HIGH VOLTAGE)



	MILLIMETERS		INCHES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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